



## TSMC Files Annual Report on Form 20-F for 2023

**HSINCHU, Taiwan, R.O.C. – Apr. 18, 2024** - TSMC (TWSE: 2330, NYSE: TSM) today filed its 2023 annual report on Form 20-F with the U.S. Securities and Exchange Commission.

The report is available at <https://investor.tsmc.com/english/sec-filings>. Hard copies of the report are also available, free of charge, upon email request to [p\\_sec\\_service@tsmc.com](mailto:p_sec_service@tsmc.com).

### About TSMC

TSMC pioneered the pure-play foundry business model when it was founded in 1987 and has been the world's leading dedicated semiconductor foundry ever since. The Company supports a thriving ecosystem of global customers and partners with the industry's leading process technologies and portfolio of design enablement solutions to unleash innovation for the global semiconductor industry. With global operations spanning Asia, Europe, and North America, TSMC serves as a committed corporate citizen around the world.

TSMC deployed 288 distinct process technologies, and manufactured 11,895 products for 528 customers in 2023 by providing broadest range of advanced, specialty and advanced packaging technology services. The Company is headquartered in Hsinchu, Taiwan. For more information please visit <https://www.tsmc.com>.

# # #

**TSMC Spokesperson:**

Wendell Huang  
Senior Vice President and CFO  
Tel: 886-3-505-5901

**Media Contacts:**

Nina Kao  
Head of Public Relations  
Tel: 886-3-563-6688 ext.712-5036  
Mobile: 886-988-239-163  
E-Mail: [nina\\_kao@tsmc.com](mailto:nina_kao@tsmc.com)

Ulric Kelly  
Public Relations  
Tel: 886-3-563-6688 ext.712-6541  
Mobile: 886-978-111-503  
E-Mail: [ukelly@tsmc.com](mailto:ukelly@tsmc.com)